RoHS

COMPLIANT

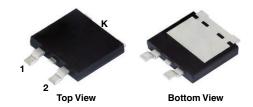
HALOGEN FREE



## Vishay General Semiconductor

# Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

### eSMP® Series SMPD (TO-263AC)



#### V10D202C



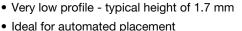
### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	2 x 5.0 A				
$V_{RRM}$	200 V				
I <sub>FSM</sub>	100 A				
$V_F$ at $I_F = 5.0$ A $(T_A = 125  ^{\circ}C)$	0.67 V				
T <sub>J</sub> max.	175 °C				
Package	SMPD (TO-263AC)				
Circuit configuration	Common cathode				

#### **FEATURES**





· Low forward voltage drop, low power losses

High efficiency operation

• Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

AEC-Q101 qualified available:

Automotive ordering code: base P/NHM3

· Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

### TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

### **MECHANICAL DATA**

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3\_X - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....) qualified

(X\_denotes revision code e.g. A, B, ...)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER  Maximum repetitive peak reverse voltage		SYMBOL	V10D202C	UNIT	
		V <sub>RRM</sub>	200	V	
Maximum average forward rectified current (fig. 1)	per device	I <sub>F(AV)</sub>	10		
	per diode		5	— A	
Maximum DC reverse voltage		$V_{DC}$	160	V	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	100	А	
Voltage rate of change (rated V <sub>R</sub> )		dV/dt	10 000	V/µs	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-40 to +175	°C	



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 25 °C	- V <sub>F</sub> <sup>(1)</sup>	0.75	-	V	
	I <sub>F</sub> = 5 A			0.82	0.9		
	I <sub>F</sub> = 2.5 A	- T <sub>A</sub> = 125 °C		0.6	-		
	I <sub>F</sub> = 5 A			0.67	0.74		
Reverse current at rated V <sub>R</sub> per diode	V <sub>R</sub> = 160 V	T <sub>A</sub> = 25 °C	- I <sub>R</sub> <sup>(2)</sup>	0.4	-	μΑ	
		T <sub>A</sub> = 125 °C		0.5	-	mA	
	V <sub>R</sub> = 200 V	T <sub>A</sub> = 25 °C		-	50	μA	
		T <sub>A</sub> = 125 °C		1.3	5	mA	

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V10D202C	UNIT	
	per diode	R <sub>0</sub> JC	3.5		
Typical thermal resistance	per device		2.5	°C/W	
	per device	R <sub>0</sub> JA (1)(2)	58		

#### Notes

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$  - junction-to -mount

(2) Free air, without heatsink

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V10D202C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel		
V10D202CHM3_B/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

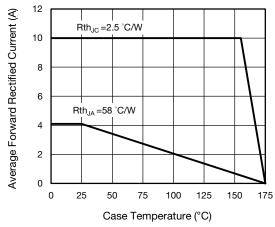


Fig. 1 - Forward Current Derating Curve

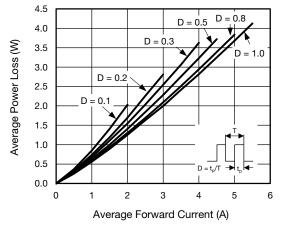


Fig. 2 - Forward Power Loss Characteristics



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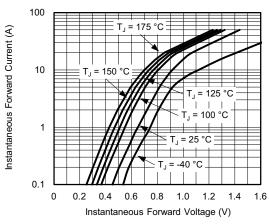


Fig. 3 - Typical Instantaneous Forward Characteristics

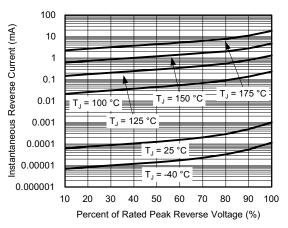


Fig. 4 - Typical Reverse Characteristics

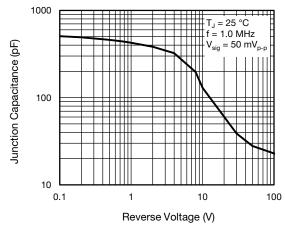


Fig. 5 - Typical Junction Capacitance

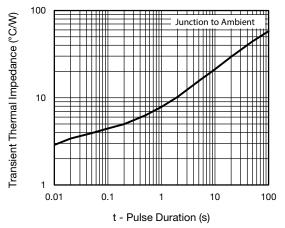


Fig. 6 - Typical Transient Thermal Impedance

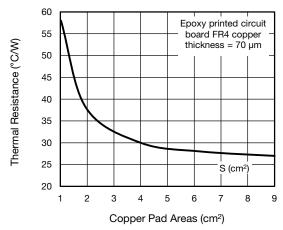
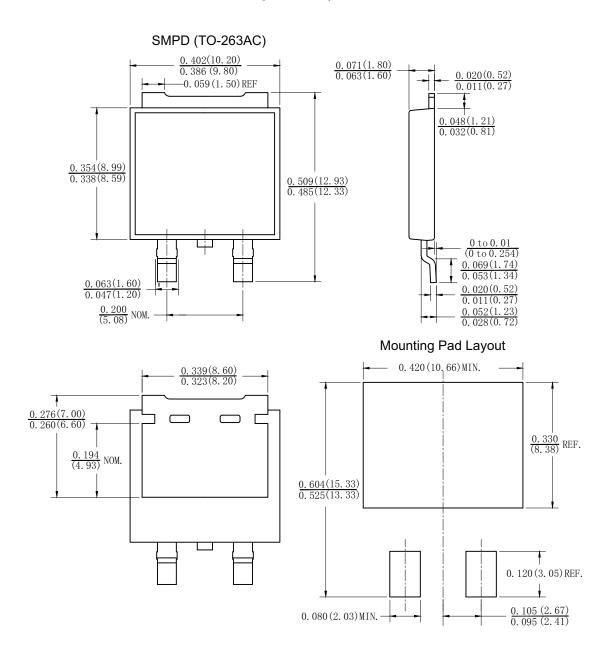


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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